

Single-Channel Power Distribution Switch

Description

The FP6861C is a cost-effective, low voltage, single N-Channel MOSFET high-side power switch, optimized for self-powered and bus-powered Universal Serial Bus (USB) applications.

The FP6861C is equipped with a charge pump circuitry to drive the internal MOSFET switch. The switch's low $R_{DS(ON)}$ meets USB voltage drop requirement, and a flag output is available to indicate fault conditions to the local USB controller.

Additional features include soft-start to limit inrush current during plug-in, thermal shutdown to prevent catastrophic switch failure from high-current loads, and under-voltage lockout (UVLO) to ensure that the device remains off unless there is a valid input voltage present. Besides, fault current is limited to specific current for FP6861C in single port in accordance with the USB power requirements. FP6861C will prevent reverse current when it is disabled and V_{OUT} is higher than V_{IN} .

The FP6861C is available in MSOP-8, SOP-8 and SOT-23-5 packages with smallest components.

Features

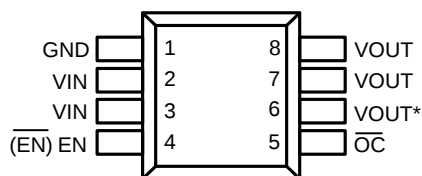
- Compliant to USB Specifications
- Built-In Low $R_{DS(ON)}$ N-Channel MOSFET
- Output can be Forced Higher than Input (Off-State)
- Low Supply Current:
65 μ A Typical at Switch On State
0.1 μ A Typical at Switch Off State
- Wide Input Voltage Ranges: 2.7V to 5.5V
- Open-Drain Fault Flag Output
- Hot Plug-In Application (Soft-Start)
- 2.2V Typical Under-Voltage Lockout (UVLO)
- Current Limit Protection
- Thermal Shutdown Protection
- Reverse Current Flow Blocking (No Body Diode)
- Logic Level Enable Pin
- MSOP-8, SOP-8 and SOT-23-5 Packages
- RoHS Compliant
- UL NO.E322418 (Approved model: FP6861 series)
- CB Test Certified, Ref. Certif. No. JPTUV-041416

Applications

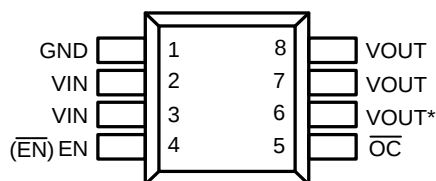
- USB Bus/Self Powered Hub
- USB Peripheral
- ACPI Power Distribution
- Notebook, Motherboard PC
- Battery-Charger Circuit

Pin Assignments

MS Package (MSOP-8)

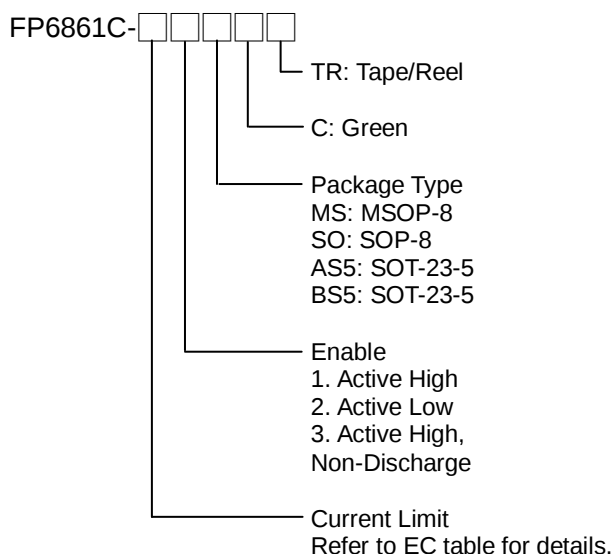


SO Package (SOP-8)



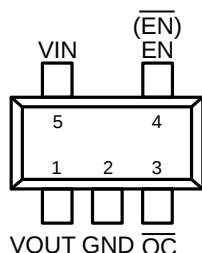
* The pin 6 should be considered as VOUT when circuit design and PCB layout, but it is NC pin actually.

Ordering Information



** Please see the Available Product List in next page.

AS5 Package (SOT-23-5)



BS5 Package (SOT-23-5)

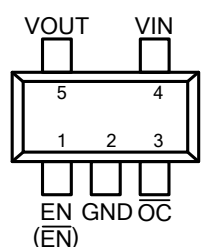


Figure1. Pin Assignment of FP6861C

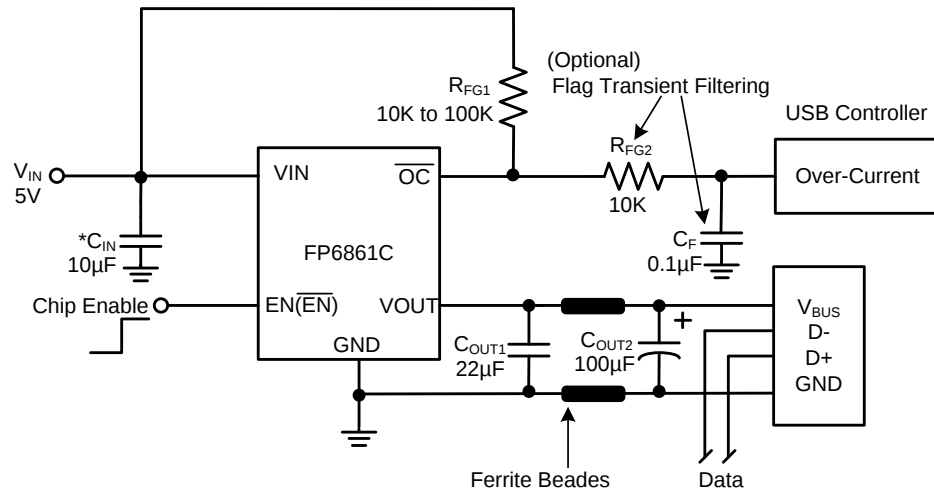
Available Product List

FP6861C-A1MSCTR	FP6861C-E1AS5CTR
FP6861C-A1AS5CTR	FP6861C-E1BS5CTR
FP6861C-A2MSCTR	FP6861C-E1MSCTR
FP6861C-A2SOCTR	FP6861C-E2AS5CTR
FP6861C-A2AS5CTR	FP6861C-F1MSCTR
FP6861C-A3AS5CTR	FP6861C-F1SOCTR
FP6861C-B1MSCTR	FP6861C-H1MSCTR
FP6861C-B1AS5CTR	FP6861C-H1SOCTR
FP6861C-B1BS5CTR	FP6861C-I1AS5CTR
FP6861C-B1SOCTR	FP6861C-I1BS5CTR
FP6861C-B2AS5CTR	FP6861C-I1SOCTR
FP6861C-B3AS5CTR	FP6861C-I2BS5CTR
FP6861C-B3BS5CTR	FP6861C-J3AS5CTR
FP6861C-B3MSCTR	
FP6861C-C1AS5CTR	
FP6861C-C1MSCTR	
FP6861C-C1SOCTR	
FP6861C-C2AS5CTR	
FP6861C-C2SOCTR	

SOT-23-5 Marking

Part Number	Product Code	Part Number	Product Code
FP6861C-A1AS5C	A9G	FP6861C-C2AS5C	A6A
FP6861C-A2AS5C	A4A	FP6861C-E1AS5C	A3A
FP6861C-A3AS5C	FN9	FP6861C-E1BS5C	E6G
FP6861C-B1AS5C	A0G	FP6861C-E2AS5C	A8A
FP6861C-B1BS5C	D7G	FP6861C-I1AS5C	F2G
FP6861C-B2AS5C	A5A	FP6861C-I1BS5C	F1G
FP6861C-B3AS5C	FiZ	FP6861C-I2BS5C	E9G
FP6861C-B3BS5C	FA1	FP6861C-J3AS5C	Fi0
FP6861C-C1AS5C	A1A		

Typical Application Circuit



*Note: In most applications, adding one 1µF capacitor is enough. If the trace to VIN is long in PCB, placing larger input capacitor is needed.

Figure 2. Typical Application Circuit

Functional Pin Description

Pin Name	Pin Function
VIN	Input Power Supply.
VOUT	Switch Output.
GND	Ground.
EN	Chip Enable. Pull the pin high to enable IC; Pull the pin low to shutdown IC. Do not let the pin floating.
$\overline{\text{EN}}$	Chip Shutdown. Pull the pin high to shutdown IC; Pull the pin low to enable IC. Do not let the pin floating.
$\overline{\text{OC}}$	Open-Drain Fault Flag Output.

The block diagram illustrates the internal architecture of the MCP1802 voltage regulator. Key components and their interconnections include:

- Inputs:** EN ($\overline{\text{EN}}$) and VIN.
- Internal Blocks:**
 - BIAS:** Receives EN and provides a reference voltage to the Gate Control block.
 - UVLO (Under Voltage Lockout):** Monitors VIN and provides a signal to the Gate Control block.
 - Oscillator:** Provides a clock signal to the Charge Pump.
 - Charge Pump:** Boosts the BIAS voltage to drive the PMOS transistor.
 - Gate Control:** Receives signals from BIAS, UVLO, and the Thermal Protection block. It drives the gates of both the PMOS and NMOS transistors.
 - Current Limiting:** Monitors the current through the PMOS transistor and provides a feedback signal to the Gate Control block.
 - Output Voltage Detection:** Monitors VOUT and provides a signal to the Gate Control block and the Delay block.
 - Thermal Protection:** Monitors the device temperature and provides a shutdown signal to the Gate Control block.
 - Delay:** Provides a time delay for the shutdown signal before it reaches the NMOS transistor gate.
- Outputs:** VOUT and OC ($\overline{\text{OC}}$).
- Ground:** GND.

The diagram shows the PMOS transistor connected to VIN and the NMOS transistor connected to GND. The output VOUT is taken from the node between the two transistors. The OC pin is connected to the NMOS transistor gate through a pull-up resistor. A note indicates that the Shutdown Signal is active-low.

Figure 3. Block Diagram

• VIN, VOUT	-----	-0.3V to +6V
• EN ($\overline{\text{EN}}$)	-----	-0.3V to +6V
• $\overline{\text{OC}}$	-----	-0.3V to +6V
• Power Dissipation @T _J =125°C & T _A =25°C (P _D)		
MSOP-8	-----	+0.63W
SOP-8	-----	+0.91W
SOT-23-5	-----	+0.4W
• Package Thermal Resistance (θ _{JA})		
MSOP-8	-----	+160°C/W
SOP-8	-----	+110°C/W
SOT-23-5	-----	+250°C/W
• Junction Temperature	-----	+150°C
• Lead Temperature (Soldering,10 sec.)	-----	+260°C
• Storage Temperature Range	-----	-65°C to +150°C

- Supply Voltage (V_{IN}) ----- +2.7V to +5.5V
- Operation Temperature Range (T_{OPR}) ----- -40°C to +85°C

Electrical Characteristics

($V_{IN}=5V$, $T_A=25^{\circ}C$, unless otherwise specified.)

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Switch On Resistance	$R_{DS(ON)}$	$I_{OUT}=70\%$ Minimum Current Limit, MSOP-8, SOP-8 package		70	100	m Ω
		$I_{OUT}=70\%$ Minimum Current Limit, SOT-23-5 package		100	125	
		FP6861C-H1, $I_{OUT}=70\%$ Minimum Current Limit		60	90	
Supply Current	I_{SW_ON}	Switch on, $V_{OUT}=Open$		65		μA
	I_{SW_OFF}	Switch off, $V_{OUT}=Open$		0.1	1	
EN Threshold	V_{IL}	Switch off			0.7	V
	V_{IH}	Switch on	1.8			
EN Input Current	I_{EN}	$V_{EN}=Enable$		0.01	0.1	μA
Current Limit	I_{LIM}	$R_{LOAD}=1\Omega$, FP6861C-A1	2.1	2.45	2.8	A
		$R_{LOAD}=1\Omega$, FP6861C-A2	2.1	2.45	2.8	
		$R_{LOAD}=1\Omega$, FP6861C-A3	2.1	2.45	2.8	
		$R_{LOAD}=1\Omega$, FP6861C-B1	1.5	1.75	2	
		$R_{LOAD}=1\Omega$, FP6861C-B2	1.5	1.75	2.1	
		$R_{LOAD}=1\Omega$, FP6861C-B3	1.5	1.75	2.1	
		$R_{LOAD}=1\Omega$, FP6861C-C1	0.7	1	1.28	
		$R_{LOAD}=1\Omega$, FP6861C-C2	0.7	1	1.35	
		$R_{LOAD}=1\Omega$, FP6861C-E1	1.1	1.4	1.7	
		$R_{LOAD}=1\Omega$, FP6861C-E2	1.1	1.4	1.7	
		$R_{LOAD}=1\Omega$, FP6861C-F1	2.5	2.95	3.4	
		$R_{LOAD}=1\Omega$, FP6861C-H1	3	3.5	4	
		$R_{LOAD}=1\Omega$, FP6861C-I1	0.55	0.775	1	
		$R_{LOAD}=1\Omega$, FP6861C-I2	0.55	0.775	1	
		$R_{LOAD}=1\Omega$, FP6861C-J3	1	1.25	1.5	
Short Circuit Fold-Back Current	I_{SC_FB}	$V_{OUT}=0V$, Measured Prior to Thermal Shutdown FP6861C-A1		0.55		A
		$V_{OUT}=0V$, Measured Prior to Thermal Shutdown FP6861C-A2		0.55		
		$V_{OUT}=0V$, Measured Prior to Thermal Shutdown FP6861C-A3		0.55		
		$V_{OUT}=0V$, Measured Prior to Thermal Shutdown FP6861C-B1		0.5		

Electrical Characteristics (Continued)

($V_{IN}=5V$, $T_A=25^{\circ}C$, unless otherwise specified.)

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Short Circuit Fold-Back Current	I_{SC_FB}	$V_{OUT}=0V$, Measured Prior to Thermal Shutdown FP6861C-B2		0.5		A
		$V_{OUT}=0V$, Measured Prior to Thermal Shutdown FP6861C-B3		0.5		
		$V_{OUT}=0V$, Measured Prior to Thermal Shutdown FP6861C-C1		0.4		
		$V_{OUT}=0V$, Measured Prior to Thermal Shutdown FP6861C-C2		0.4		
		$V_{OUT}=0V$, Measured Prior to Thermal Shutdown FP6861C-E1		0.45		
		$V_{OUT}=0V$, Measured Prior to Thermal Shutdown FP6861C-E2		0.45		
		$V_{OUT}=0V$, Measured Prior to Thermal Shutdown FP6861C-F1		0.6		
		$V_{OUT}=0V$, Measured Prior to Thermal Shutdown FP6861C-H1		0.65		
		$V_{OUT}=0V$, Measured Prior to Thermal Shutdown FP6861C-I1		0.45		
		$V_{OUT}=0V$, Measured Prior to Thermal Shutdown FP6861C-I2		0.45		
		$V_{OUT}=0V$, Measured Prior to Thermal Shutdown FP6861C-J3		0.45		
Output Leakage Current	$I_{LEAKAGE}$	$V_{EN}=Disable$, $R_{LOAD}=0\Omega$		0.5	1	μA
Output Turn-On Rise Time	T_{ON_RISE}	10% to 90% of V_{OUT} Rising, $C_L=120\mu F$		250		μs
		10% to 90% of V_{OUT} Rising, $C_L=120\mu F$ FP6861C-B1		500		μs
$\overline{OC}$ Output Resistance	$R_{\overline{OC}}$	$I_{SINK}=1mA$		70		Ω
$\overline{OC}$ Off Current	$I_{\overline{OC}}$	$V_{\overline{OC}}=5V$		0.01		μA
$\overline{OC}$ Delay Time	t_D	From Fault Condition to $\overline{OC}$ Assertion		10		ms
Under-Voltage Lockout	V_{UVLO}	V_{IN} Increasing		2.2		V
Under-Voltage Hysteresis	ΔV_{UVLO}	V_{IN} Decreasing		0.2		V
Shutdown Pull Low Resistance (Note 2)	R_{PD}			80		Ω
		FP6861C-C2		190		Ω

Electrical Characteristics (Continued)

($V_{IN}=5V$, $T_A=25^{\circ}C$, unless otherwise specified.)

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Thermal Shutdown Threshold ^(Note 3)	T_{SD}			135		$^{\circ}C$
	ΔT_{SD}	Hysteresis		20		$^{\circ}C$

Note 2: There is no resistor for FP6861C-x3xxx series.

Note 3: Guarantee by design.

Test Circuit

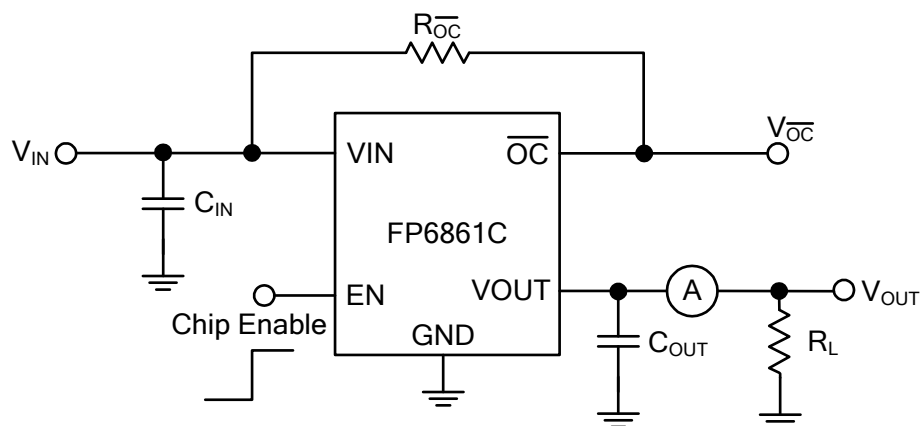


Figure 4. Electrical Characteristic Test Circuit of FP6861C

Typical Performance Curves

$V_{IN}=V_{OUT}=5V$, $C_{IN}=100\mu F$, $C_{OUT}=120\mu F$, $T_A=+25^\circ C$, unless otherwise noted. This is measured by using FP6861C-A2MSCTR.

$I_{OUT}=0A$

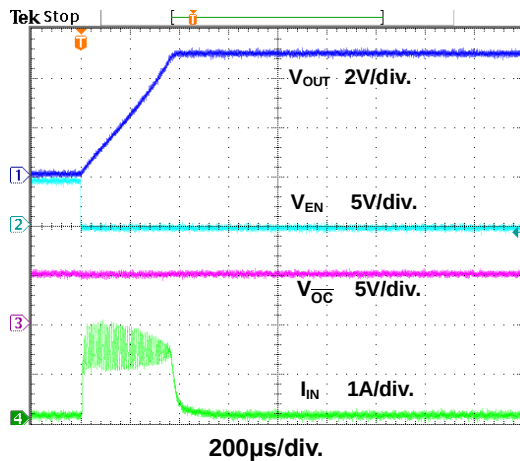


Figure 5. EN Start-Up

$I_{OUT}=1.3A$ (3.8Ω)

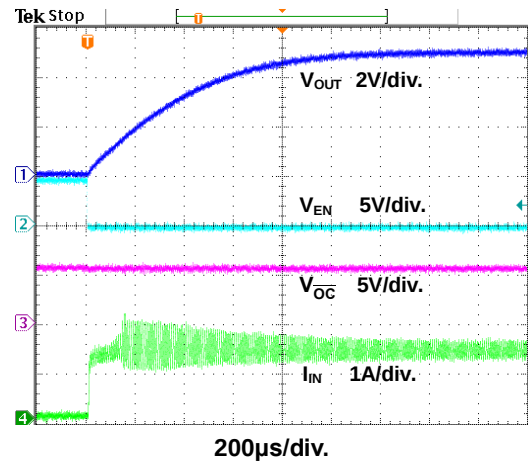


Figure 6. EN Start-Up

$I_{OUT}=0A$

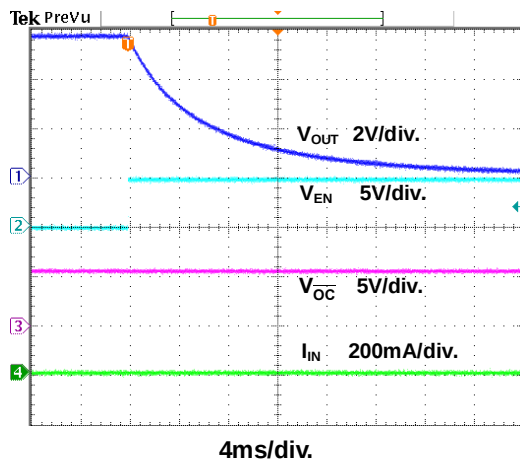


Figure 7. EN Power Off Test

$I_{OUT}=1.3A$ (3.8Ω)

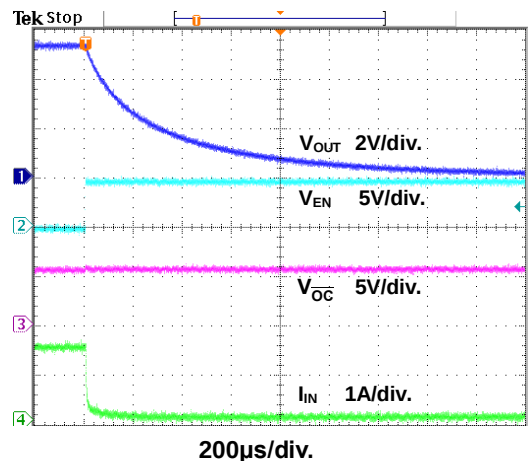


Figure 8. EN Power Off Test

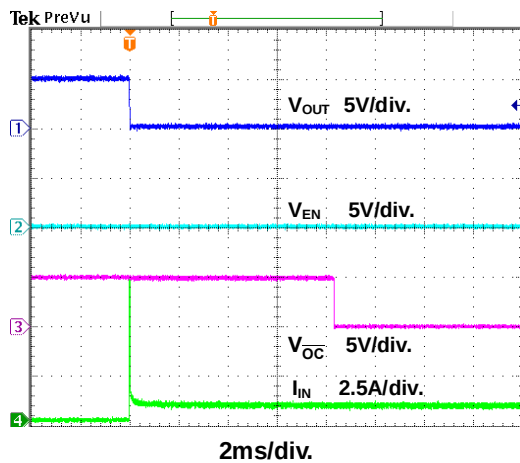


Figure 9. Inrush Short Circuit Response

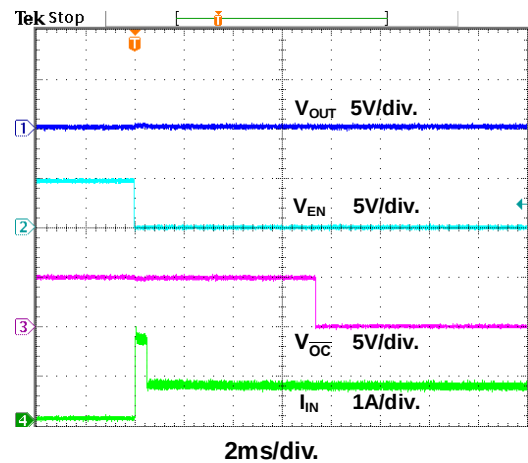


Figure 10. Short Circuit Response at Start Up

Typical Performance Curves (Continued)

$V_{IN}=V_{OUT}=5V$, $C_{IN}=100\mu F$, $C_{OUT}=120\mu F$, $T_A=+25^\circ C$, unless otherwise noted. This is measured by using FP6861C-A2MSCTR.

$I_{OUT}=0A\sim 1.3A$

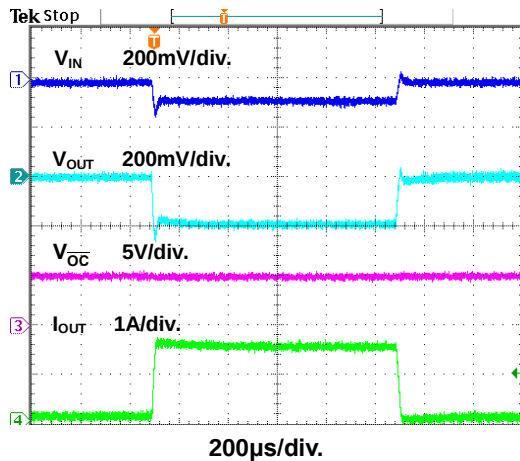


Figure 11. Load transient

$C_{OUT}=120\mu F+100\mu F$ electronic capacitors

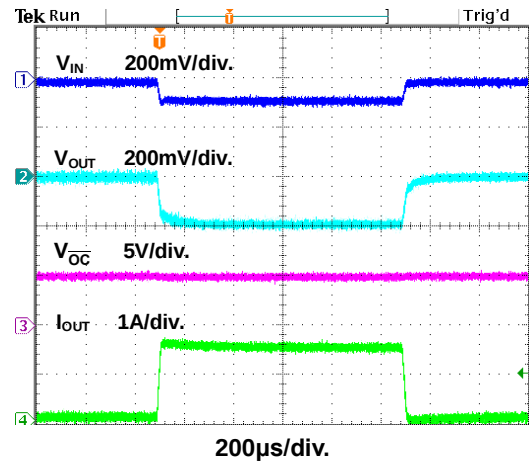


Figure 12. Load transient

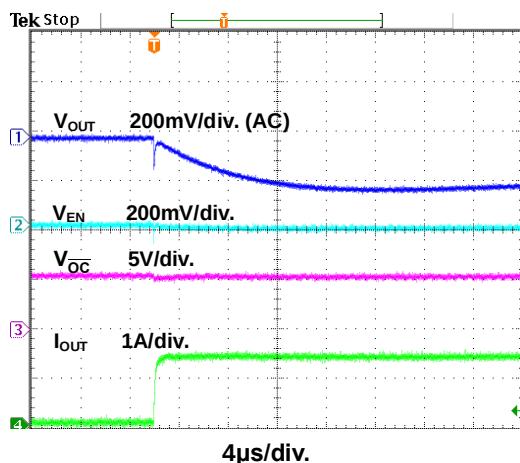


Figure 13. Output Load Insert Hot Plug-In with 3.8Ω (1.3A)

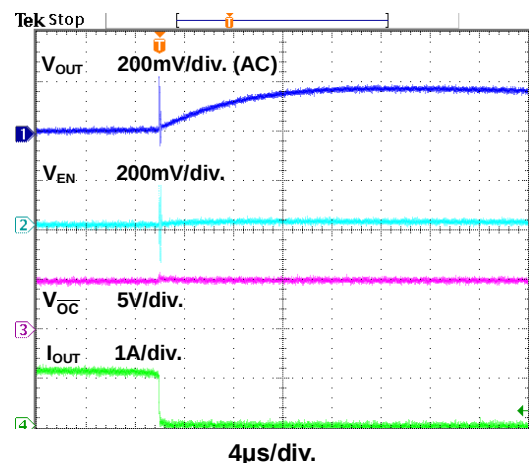


Figure 14. Output Load Insert Hot Plug-Off with 3.8Ω (1.3A)

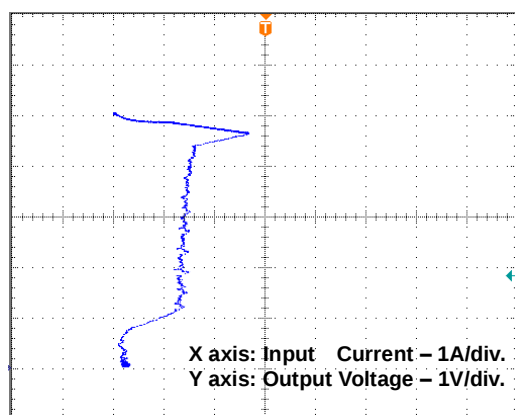


Figure 15. Over Current Protection Characteristics

Typical Performance Curves (Continued)

$V_{IN} = V_{OUT} = 5V$, $C_{IN} = 100\mu F$, $C_{OUT} = 120\mu F$, $T_A = +25^\circ C$, unless otherwise noted. This is measured by using FP6861C-A2MSCTR.

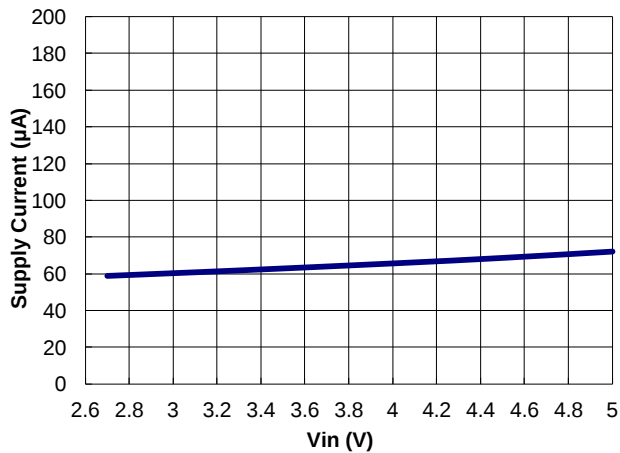


Figure 16. Supply Current vs. Input Voltage

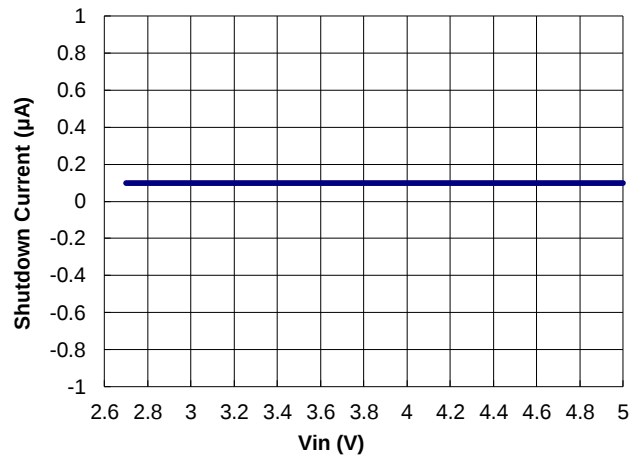


Figure 17. Shutdown Current vs. Input Voltage

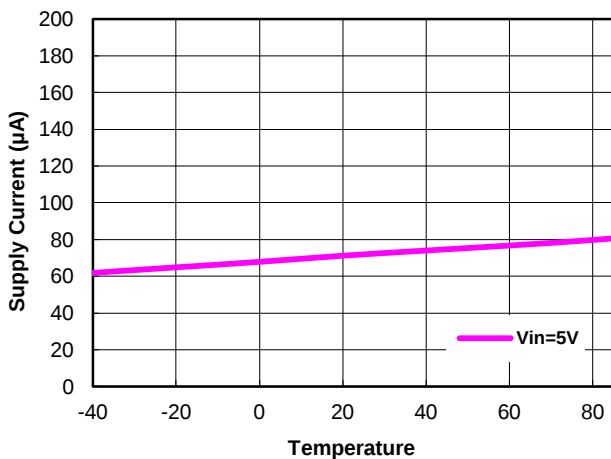


Figure 18. Supply Current vs. Temperature

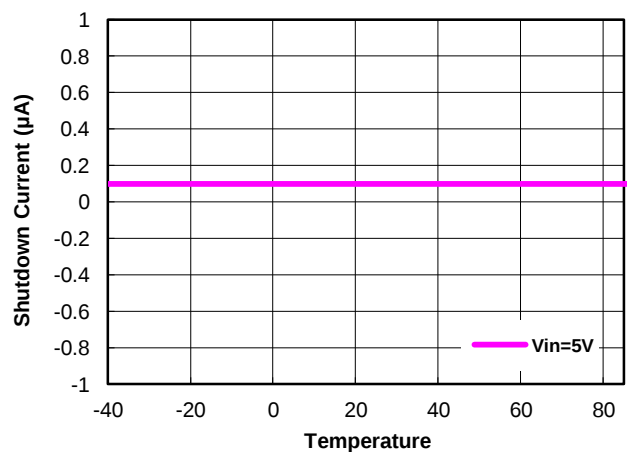


Figure 19. Shutdown Current vs. Temperature

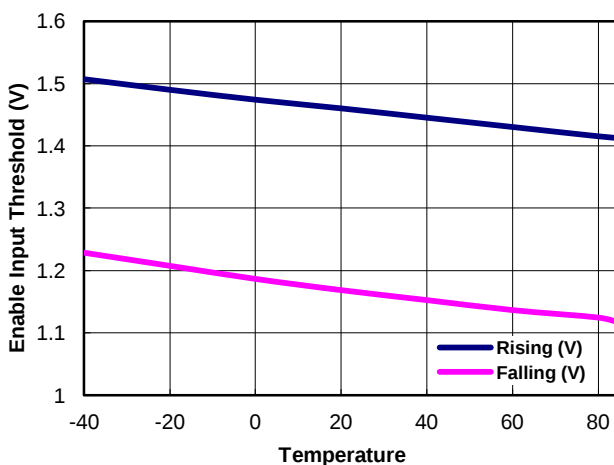


Figure 20. Enable Input Threshold vs. Temperature

Application Information

The FP6861C is a single N-Channel MOSFET high-side power switch, optimized for self-powered and bus-powered Universal Serial Bus (USB) applications. The FP6861C operates from 2.7V to 5.5V input voltage range and provides low supply current. The switch's low $R_{DS(ON)}$, 70m Ω , meets USB voltage drop requirements. It has one switch with enable control input. The switch has an error flag output to notify the USB controller when the current-limit, short-circuit or thermal-shutdown occurs.

Under Voltage-Lockout

Under-voltage Lockout (UVLO) prevents the MOSFET switch from turning on until input voltage exceeds approximately 2.2V. If input voltage drops below approximately 2V, UVLO will turn off the MOSFET switch.

Thermal Shutdown

Thermal shutdown is employed to protect the device from damage if the die temperature exceeds safe margins mainly due to short-circuit or current-limit. Thermal shutdown will shut the switch off and cause the $\overline{OC}$ output to go low.

Reverse Current Blocking

The USB specification does not allow an output device to source current back into the USB port. However, the FP6861C is designed to safely power noncompliant devices. When the device is disabled, the output will be switched to a high-impedance state, blocking reverse current flow from the output back to the input. The switch is bidirectional when it is enabled.

Error Flag

The FP6861C provides an open drain error flag output for the switch. For most applications, connect $\overline{OC}$ to VIN through a pull-up resistor. $\overline{OC}$ will go low when any following condition occurs:

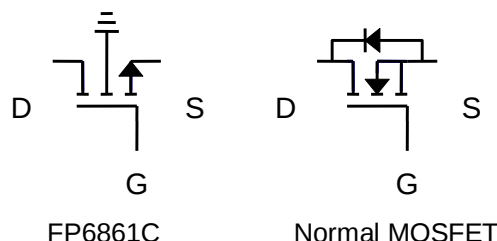
- The thermal shutdown occurs.
- The switch is in current limit or short circuit conditions.

Fast Shutdown Load Discharge

The FP6861C provides a pull down resistance when the device is off. The resistance could discharge the load capacitor fast (refer to the block diagram). (FP6861C-x3xxx series is non-discharge.)

Input and Output

VIN is the power source connection to the internal circuitry and the drain of the MOSFET. VOUT is the source of the MOSFET. In typical application, current flows through the switch from VIN to VOUT toward the load. If VOUT is greater than VIN, current will flow from VOUT to VIN since the MOSFET is bidirectional. There is no parasitic body diode between drain and source of the MOSFET, and the FP6861C will prevent reverse current flow if VOUT externally forces a higher voltage than VIN when the output is disabled.



Soft Start for Hot Plug-In Application

In order to eliminate the upstream voltage drop caused by the large inrush current during hot-plug events, the "soft-start" feature effectively isolates the power source from extremely large capacitive loads, satisfying the USB voltage drop requirements.

Current Limit and Short-Circuit Protection

The current limit circuitry prevents damage to the MOSFET switch and the hub downstream port but can deliver load current up to the current limit threshold through the switch of FP6861C. When a heavy load or short circuit is applied to an enabled switch, a large transient current may flow until the current limit circuitry responds. Once exceeds the current limit threshold, the device will enter constant current mode until the thermal shutdown occurs or the fault is removed.

Application Information (Continued)

Supply Filter/Bypass Capacitor

The input capacitor must be at least 1μF low-ESR ceramic capacitor connected from VIN to GND, but can be increased without limit. Output short may cause sufficient ringing on the input (from source lead inductance) to destroy the internal control circuitry. The input transient must not exceed 6V of the absolute maximum supply voltage even for a short duration.

Output Filter Capacitor

Output is recommended to use a 22μF ceramic capacitor in parallel with a 100μF electrolytic capacitor. Standard bypass methods should be used to minimize inductance and resistance between the bypass capacitor and the downstream connector which reduce EMI and decouple voltage drop caused when downstream cables are hot-insertion transients. Ferrite beads in series with V_{BUS}, the ground line and the 0.1μF bypass capacitors at the power connector pins are recommended for EMI and ESD protection. The bypass capacitor should have a low dissipation factor to allow decoupling at higher frequencies.

Power Dissipation

The device's junction temperature depends on several factors, such as the load, PCB layout, ambient temperature and package type. However, the maximum output current must be decreased at higher ambient temperature to ensure the junction temperature does not exceed 150°C. With all possible conditions, the junction temperature must be within the range specified under operating conditions. Power dissipation can be calculated based on the output current and the R_{DS(ON)} of switch as below:

$$P_D = R_{DS(ON)} \times (I_{OUT})^2$$

Although the devices are rated by current limit, but the application may limit the amount of output current based on the total power dissipation and the ambient temperature. The final operating junction temperature for any set of conditions can be estimated by the following thermal equation:

$$P_{D(MAX)} = \frac{T_{J(MAX)} - T_A}{\theta_{JA}}$$

where T_{J(MAX)} is the maximum junction temperature 125°C, T_A is the ambient temperature and the θ_{JA} is the junction to ambient thermal resistance.

The junction to ambient thermal resistance θ_{JA} is related to layout. For SOT-23-5 package, the thermal resistance θ_{JA} is 250°C/W on the standard JEDEC 51-3 single-layer thermal test board.

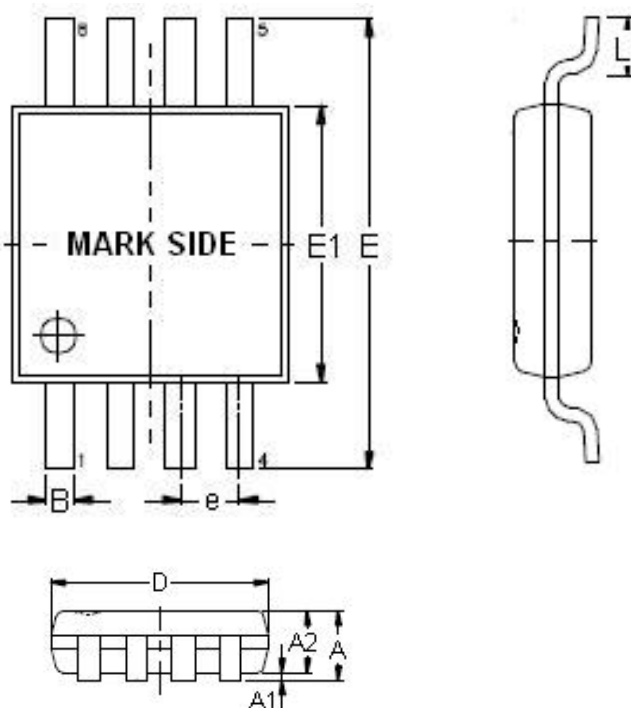
PCB Layout

In order to meet the voltage drop and EMI requirements, careful PCB layout is necessary. The following guidelines must be considered:

1. Keep all V_{BUS} traces as short as possible, and use at least 50-mil and 2 ounce copper for all V_{BUS} traces.
2. Locate the FP6861C as close to the output port as possible to limit switching noise.
3. Locate the ceramic bypass capacitors as close to the VIN pins of the FP6861C as possible.
4. Avoid vias as much as possible. If vias are necessary, make them as large as feasible.
5. Place a ground plane under all circuitry to lower both resistance and inductance, and improve DC and transient performance (use a separate ground and power plans if possible).
6. Place cuts in the ground plane between ports to help reducing the coupling of transients between ports.
7. Locate the output capacitor and ferrite beads as close to the USB connectors as possible to lower impedance (mainly inductance) between the port and the capacitor, and improve transient load performance.

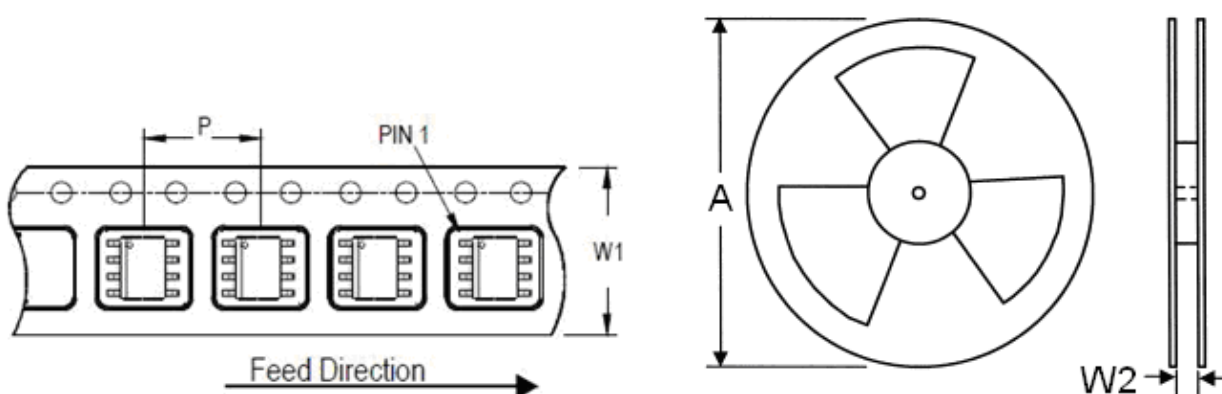
Outline Information

MSOP-8 Package (Unit: mm)



SYMBOLS UNIT	DIMENSION IN MILLIMETER	
	MIN	MAX
A	0.75	1.10
A1	0.00	0.15
A2	0.75	0.95
B	0.25	0.35
D	2.90	3.10
E	4.80	5.00
E1	2.90	3.10
e	0.60	0.70
L	0.40	0.80

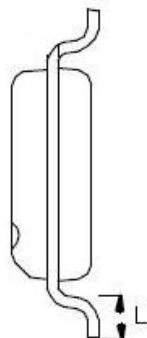
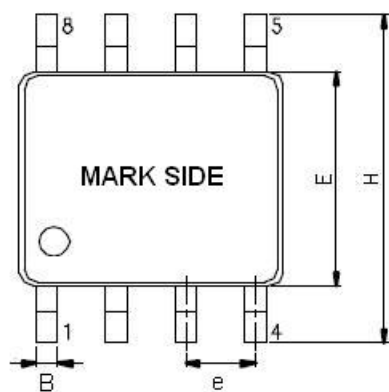
Carrier Dimensions



Tape Size (W1) mm	Pocket Pitch (P) mm	Reel Size (A)		Reel Width (W2) mm	Empty Cavity Length mm	Units per Reel
		in	mm			
12	8	13	330	12.4	400~1000	3,000

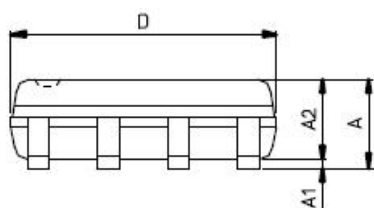
Outline Information (Continued)

SOP-8 Package (Unit: mm)

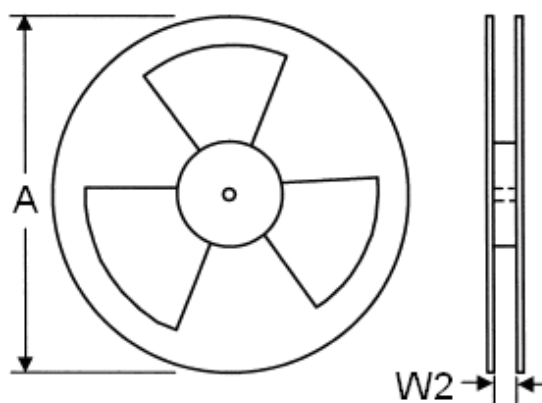
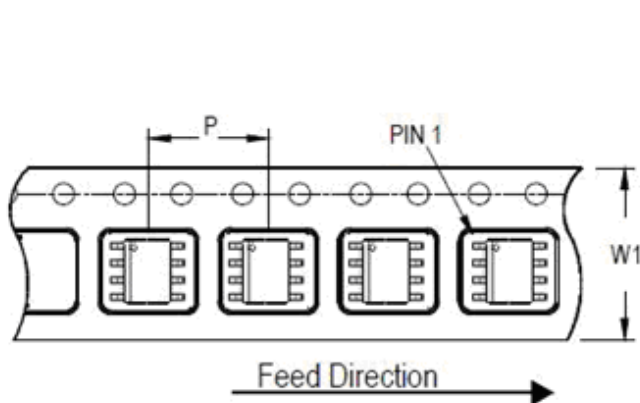


SYMBOLS UNIT	DIMENSION IN MILLIMETER	
	MIN	MAX
A	1.35	1.75
A1	0.10	0.25
A2	1.25	1.50
B	0.31	0.51
D	4.80	5.00
E	3.80	4.00
e	1.20	1.34
H	5.80	6.20
L	0.40	1.27

Note : Followed From JEDEC MO-012-E.



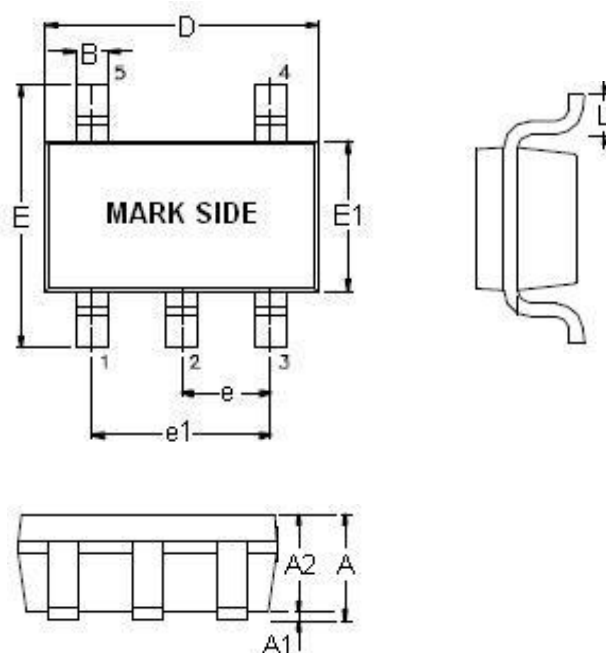
Carrier Dimensions



Tape Size (W1) mm	Pocket Pitch (P) mm	Reel Size (A)		Reel Width (W2) mm	Empty Cavity Length mm	Units per Reel
		in	mm			
12	8	13	330	12.4	400~1000	2,500

Outline Information (Continued)

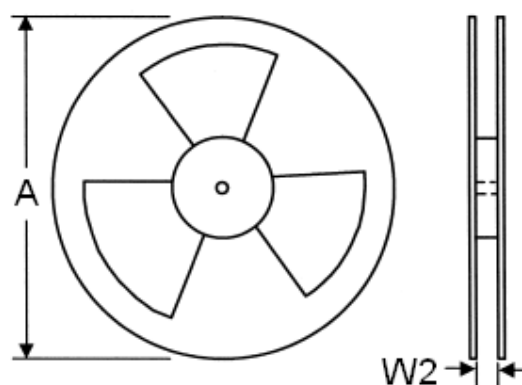
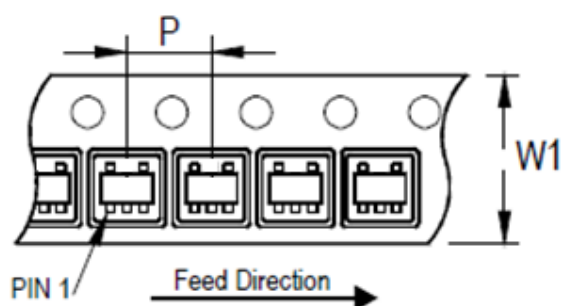
SOT-23-5 Package (Unit: mm)



SYMBOLS UNIT	DIMENSION IN MILLIMETER	
	MIN	MAX
A	0.90	1.45
A1	0.00	0.15
A2	0.90	1.30
B	0.30	0.50
D	2.80	3.00
E	2.60	3.00
E1	1.50	1.70
e	0.90	1.00
e1	1.80	2.00
L	0.30	0.60

Note : Followed From JEDEC MO-178-C.

Carrier Dimensions



Tape Size (W1) mm	Pocket Pitch (P) mm	Reel Size (A)		Reel Width (W2) mm	Empty Cavity Length mm	Units per Reel
		in	mm			
8	4	7	180	8.4	300~1000	3,000

Life Support Policy

Fitipower's products are not authorized for use as critical components in life support devices or other medical systems.